Commercial Chip - X7R 16Vdc to 10kVdc

A range of commercial MLC chip capacitors in Stable EIA Class II dielectric. Class II X7R chips are used as decoupling, by-pass, filtering and transient voltage suppression elements and exhibit +/-15% temperature coefficient and predictable variation of electrical properties with time, temperature and voltage.

Designed for surface mount application with nickel barrier terminations making them suitable for solder wave and reflow solder board attachment as well as vapor phase attachment for part sizes 2225 or smaller. Silver-palladium terminations are also available for hybrid use with conductive epoxy.

Standard EIA case sizes and available C/V values are listed below - special sizes, thicknesses and other voltage ratings are available; please contact the sales office for information.

Capacitance and voltage selection for popular chip sizes

Size	0402	0504	0603	0805	1005	1206	1210	1515	1808		1812		1825	
Min cap.	121	121	121	121	121	121	121	151	151	151	151	151	471	471
Tmax inches: mm:	0. 024 0.61	0.044 1.12	0.035 0.89	0.054 1.37	0.054 1.37	0.064 1.63	0.065 1.63	0.130 3.02	0.065 1.63	0.080* 2.03	0.065 1.63	0.100* 2.54	0.080 2.03	0.140* 3.56
16V	562	393	273	124	154	334	474	125	684	824	125	155	185	225
25V	472	333	223	104	124	274	474	105	564	564	105	125	155	225
50V	472	333	223	104	124	274	474	824	394	564	824	125	155	225
100V	472	333	223	683	823	184	334	684	274	394	564	824	125	185
200V	222	153	103	333	473	104	184	564	184	224	334	564	824	155
250V	152	103	682	273	393	683	124	394	124	154	224	394	684	125
300V	•	•	•	153	183	473	823	274	823	104	154	224	474	824
400V	•	•	•	123	123	273	563	224	563	823	104	184	334	564
500V	•	•	•	123	822	223	563	154	563	683	104	154	334	474
600V	•	•	•	822	822	183	393	124	393	563	683	124	224	394
800V†	•	•	•	472	472	103	273	823	273	333	473	683	124	274
1kV†	•	•	•	272	272	682	153	563	153	223	273	473	823	154
1.5kV†	•	•	•	•	•	222	472	183	472	682	822	153	273	563
2kV†	•	•	•	•	•	102	222	822	272	332	472	682	123	273
3kV†	•	•	•	•	•	•	•	152	561	821	122	222	272	472
4kV†	•	•	•	•	•	•	•	122	331	391	681	122	152	272
5kV†	•	•	•	•	•	•	•	•	•	•	•	•	821	182
6kV†	•	•	•	•	•	•	•	•	•	•	•	•	•	•
7kV†	•	•	•	•	•	•	•	•	•	•	•	•	•	•
8kV†	•	•	•	•	•	•	•	•	•	•	•	•	•	•
9kV†	•	•	•	•	•	•	•	•	•	•	•	•	•	
10kV†	•	•	•	•	•	•	•	•	•	•	•	•	•	•

† Units rated above 800V may require conformal coating to preclude arcing over chip surface

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Commercial Chip - X7R 16Vdc to 10kVdc

- For dielectric characteristics see page 6.
- For dimensions see page 12.
- For termination options see pages 3 & 15.
- For capacitance tolerances available see page 15.
- For ordering information see page 15.

Note: Maximum capacitance values are shown below as 3 digit code: 2 significant figures followed by the no. of zeros e.g. 183 = 18,000pF.

Capacitance and voltage selection for popular chip sizes

2020	2221	2225		2520	3333	3530	4040	4540	5440	5550	6560	7565	Size
471	471	471	471	102	102	102	102	102	102	102	222	222	Min cap.
0.180 4.57	0.080 2.03	0.080 2.03	0.150* 3.81	0.180 4.57	0.250 6.35	0.250 6.35	0.300 7.62	0.300 7.62	0.300 7.62	0.300 7.62	0.300 7.62	0.300 7.62	:inches Tmax :mm
185	155	225	275	355	525	525	825	905	106	126	206	256	16V
155	125	185	225	325	505	505	755	805	106	106	186	226	25V
155	125	185	225	325	425	425	705	755	905	106	156	206	50V
155	125	155	225	275	405	405	625	685	825	905	126	186	100V
125	684	105	185	225	355	355	565	625	705	825	825	156	200V
105	564	824	155	185	325	325	505	605	685	805	825	126	250V
824	394	474	105	125	225	225	475	505	575	705	755	106	300V
564	274	394	684	824	125	125	255	275	305	375	545	875	400V
474	274	334	564	684	105	105	185	185	185	225	335	475	500V
274	224	274	474	394	684	684	155	155	155	225	275	395	600V
224	124	154	334	274	474	394	684	824	105	155	225	275	800V†
154	823	104	224	184	334	334	564	684	684	105	155	185	1kV†
393	273	333	683	563	124	124	274	334	344	474	684	824	1.5kV†
273	123	153	333	273	823	683	154	184	184	274	394	474	2kV†
472	272	332	682	822	333	273	473	563	683	823	124	184	3kV†
272	152	152	332	472	183	153	223	333	393	473	823	104	4kV†
152	821	102	222	272	123	103	123	183	223	333	473	563	5kV†
•	•	•	•	•	682	562	822	123	153	223	333	393	6kV†
•	•	•	•	•	472	472	562	822	103	153	223	273	7kV†
•	•	•	•	•	•	332	472	682	822	123	153	223	8kV†
•	•	•	•	•	•	272	332	472	562	103	123	183	9kV†
•	•	•	•	•	•	182	272	392	472	682	103	123	10kV†

* Denotes non standard chip thickness.
Order code needs to have an 'X' inserted together with the dimension in inches e.g. X080 where dimension is 0.080"

Chip Ordering Information

Prefix	Case Size	Dielectric	Capacitance	Capacitance Tolerance	Voltage	Termination	Special Thickness	High Reliability Testing	Packaging	Marking		High Reliability Test Criteria
XX	1206	N	472	J	101	N	X050	H	T	M	-	HB

Capacitance Code

1st two digits are significant, third digit denotes number of zeros, R = decimal
Examples:

1R0 =	1.0pF
120 =	12pF
471 =	470pF
102 =	1,000pF
273 =	0.027µF
474 =	0.47µF
105 =	1.0µF

Special Thickness

None	Standard thickness as per Novacap catalog specifications
X	Denotes a special thickness other than standard. Specify in inches if required. (As shown above **X** = 0.050")

Packaging

None	Bulk
T	Tape & Reel
W	Waffle Pack

Marking

None	Unmarked
M	Marked *Marking not available on sizes ≤ 0603

High Reliability Testing

None	Standard product
H	High Reliability Testing
H	High Temp Screening

Hi-Reliability Testing Criteria

HB	MIL-PRF-55681 Group A
HV	MIL-PRF-49467 Group A
HS	MIL-PRF-123 Group A

Dielectric Codes

N	C0G/NP0	Ultra Stable
M	C0G/NP0	Ultra Stable Magnetic Free
F	C0G/NP0	High Temp. (up to 160°C)
D	C0G/NP0	High Temp. (up to 200°C)
K	R3L	Ultra Stable
R	R2D	Pulse Energy
Y	Y5V	General Purpose
Z	Z5U	General Purpose
B	X7R	Stable
C	X7R	Stable Magnetic Free
X	BX	MIL
S	X8R	High Temp. (up to 150°C)
E	Class II	High Temp. (up to 200°C)
G	Class II	High Temp. (up to 160°C)
W	X5R	Stable
RN	Lead free C0G/NP0	Ultra Stable
RB	Lead free X7R	Stable
BB	X7R BME	Stable
BW	X5R BME	Stable

Voltage Code

1st two digits are significant, third digit denotes number of zeros. For example:

160	=	16 Volts
101	=	100 Volts
501	=	500 Volts
102	=	1,000 Volts
502	=	5,000 Volts
103	=	10,000 Volts

Termination Codes

P	Palladium Silver	
PR	Palladium Silver*	
K	Solderable Palladium Silver*	
N	Nickel Barrier*	100% tin
Y	Nickel Barrier	90% tin, 10% lead
NG	Nickel Barrier Gold Flash*	
C	FlexiCap™/Nickel Barrier*	100% tin
D	FlexiCap™/Nickel Barrier	90% tin, 10% lead
B	Copper Barrier*	100% tin
E	Copper Barrier	90% tin, 10% lead
S	Silver*	

* Indicates RoHS terminations

Capacitance Tolerance Codes

Code	Tolerance (* Not RF series)		C0G/NP0 N	C0G/NP0 M	C0G/NP0 F/D	R3L K	R2D R	Y5V Z5U Y/Z	X7R B	X7R C	BX X	X8R S	Class II E/G	X5R W	Positive VTC P
B	±0.10pF	Cap. Value < 10pF	•	•											
C	±0.25pF		•	•		•									
D	±0.50pF		•	•		•									
F	±1%		•	•	•										
G	±2%		•	•	•	•									
J	±5%		•	•	•	•	•		•*	•	•*	•	•		
K	±10%		•	•	•	•	•		•	•	•	•	•	•	•
M	±20%		•		•	•	•	•	•	•	•	•	•	•	•
Z	+80% -20%		•				•	•	•*						•
P	+100% -0%		•				•	•	•*						•

Prefix Definitions

None	Standard chip	
RF	Improved ESR Capacitor	p. 23
LS	Y³ Certified Safety Capacitor	p. 42 - 43
ES	Y² Certified Safety Capacitor	p. 42 - 43
ST	Stacked Capacitor Assembly	p. 48 - 53
SM	Stacked Hi-Rel Capacitor Assembly	p. 48 - 53
CR	Cap-Rack Capacitor Array	p. 54
RC	Bleed Resistor	p. 58 - 61

Technical Summary

Technical Information

Novacap provides application notes throughout this catalog as a guide to chip selection and attachment methods. Refer to the Novacap Technical Brochure found at www.novacap.com for more details. This technical information includes the nature of capacitance, dielectric properties, electrical properties, classes of dielectrics, ferroelectric behavior, test standards, and high reliability test plans. Please do not hesitate to contact the sales office for any product or technical assistance.

Capacitor Size

Size availability is based primarily on capacitance values and voltage rating. Smaller units are generally less expensive. Because mass affects the thermal shock susceptibility of chip capacitors, size selection should consider the soldering method used to attach the chip to the board. Sizes 1812 and smaller can be wave, vapor phase, or reflow soldered. Larger units require reflow soldering.

Chip Selection

Multilayer capacitors (MLC) are categorized by dielectric performance with temperature. The Temperature Coefficient of Capacitance describes the variance of capacitance value with temperature. The choice of components is therefore largely determined by the temperature stability required of the device and the size necessary for the desired capacitance value and voltage rating.

Packaging

Units are available reeled, in waffle pack, or bulk packaged. Bar coded labels are standard for reeled and bulk packaging.

Primary Dielectric Types

C0G/NP0:

Ultra stable Class I dielectric, with negligible dependence of capacitance on temperature, voltage, frequency, and time. Used in circuitry requiring very stable performance.

X7R:

Stable Class II dielectric, with predictable change in properties across a temperature range of -55°C to +125°C. Used as blocking, decoupling, bypassing, and frequency discriminating elements. This dielectric is ferroelectric and provides higher capacitance than Class I materials.

BX:

The military specification for ceramic chip capacitors (MIL-PRF-55681) defines a mid-K stable dielectric designated as BX. The BX specification has voltage temperature limits in addition to temperature limits of capacitance. The BX dielectric is limited to ±15% maximum change in capacitance between 25°C and -55°C or +125°C and also has a voltage restriction of +15% / -25% maximum change in capacitance between 25°C and -55°C or +125°C at rated voltage.

Z5U/Y5V:

General purpose Class III dielectrics with higher dielectric constant and greater variation of properties over temperature and voltage. Very high capacitance per volume is attainable for general purpose applications where stability over a wide temperature range is not critical.

Dielectric Termination Combinations

Dielectric	Code	Palladium Silver	Palladium Silver RoHS	Solderable Palladium Silver RoHS	Nickel Barrier 100% tin RoHS	Nickel Barrier 90/10% tin/lead	Nickel Barrier Gold flash RoHS	FlexiCap™/Nickel Barrier 100% tin RoHS	FlexiCap™/Nickel Barrier 90/10% tin/lead	Copper Barrier 100% tin RoHS	Copper Barrier 90/10% tin/lead	Solderable Silver RoHS
		P	PR	K	N	Y	NG	C	D	B	E	S
C0G/NP0	N/RN	•	•	•	•	•	•	•	•			•
R3L	K	•	•	•	•	•	•	•	•			
X7R	B/RB	•	•	•	•	•	•	•	•			•
X7R BME	BB				•	•	•					
X5R BME	BW				•	•	•					
BX	X	•	•	•	•	•	•	•	•			•
Y5V	Y							•	•			
Z5U	Z							•	•			
C0G/NP0 (Mag free)	M	•	•	•						•	•	
X7R (Mag free)	C	•	•	•						•	•	
X8R	S	•	•	•	•	•		•	•			•
C0G/NP0 (160°C)	F	•	•	•	•	•		•	•			•
C0G/NP0 (200°C)	D			•								•
Class II (160°C)	G	•	•	•	•	•		•	•			•
Class II (200°C)	E			•								•
Pulse Power	P	•	•	•								
R2D	R	•	•	•								

Termination Material

We recommend the following termination types:

Solder Attachment:

N Nickel Barrier, 100% matte tin plated - RoHS

C FlexiCap™ with Nickel Barrier, 100% tin plated - RoHS

Y Nickel Barrier, tin-lead plated

D FlexiCap™ Nickel Barrier, tin-lead plated

B Copper Barrier 100% matte tin plated - RoHS

E Copper Barrier, tin-lead plated

K Solderable Palladium Silver - RoHS (suitable for conductive epoxy attach)

S Solderable Silver - RoHS

Conductive Epoxy attachment:

P Palladium Silver

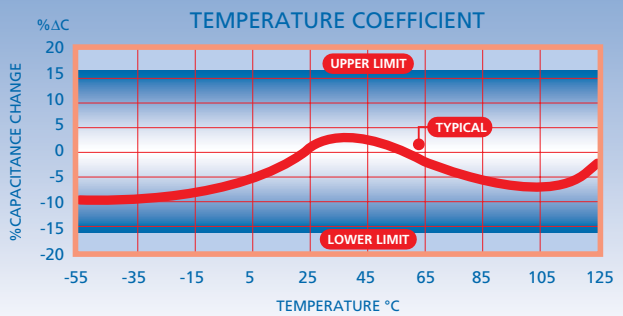
PR Palladium Silver - RoHS

NG Nickel Barrier Gold Flash - RoHS (suitable for soldering attach)

Dielectric Characteristics

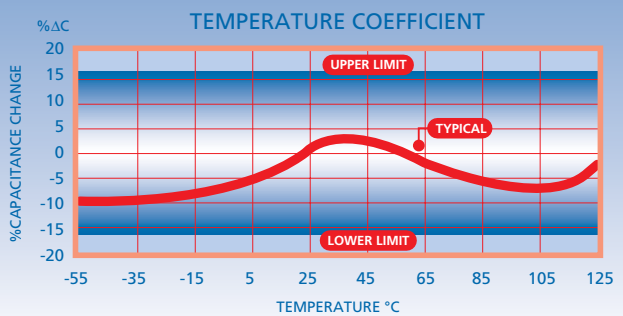
X7R (B) Stable and RoHS 2013 (RB) type

Operating temperature range:		-55°C to 125°C
Temperature coefficient :		±15% ΔC Max.
Dissipation factor	>25V rating: ≤25V rating:	2.5% max 3.5% max
Insulation resistance:	@25°C: @125°C:	>100GΩ or >1000ΩF whichever is less >10GΩ or >100ΩF whichever is less
Dielectric withstanding voltage	≤200V: 201-500V: >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:		<2.0% per decade
Test parameters:		1KHz, 1.0 ±0.2 VRMS, 25°C



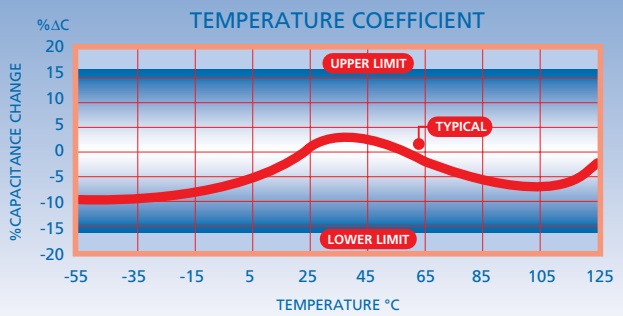
X7R (C) Stable Non Magnetic

Operating temperature range:		-55°C to 125°C
Temperature coefficient:		±15% ΔC Max.
Dissipation factor	>25V rating: ≤25V rating:	2.5% max 3.5% max
Insulation resistance:	@25°C: @125°C:	>100GΩ or >1000ΩF whichever is less >10GΩ or >100ΩF whichever is less
Dielectric withstanding voltage	≤200V: 201-500V: >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:		<2.0% per decade
Test parameters:		1KHz, 1.0 ±0.2 VRMS, 25°C



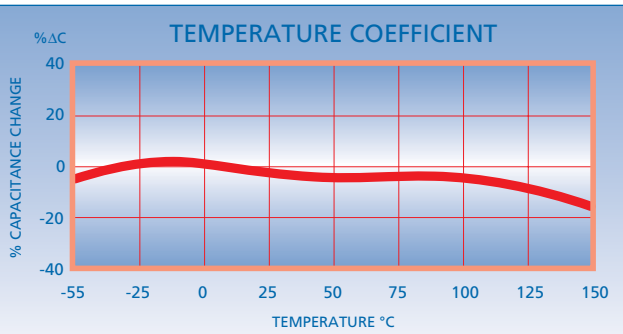
BX (X) Stable

Operating temperature range:		-55°C to 125°C
Temperature coefficient: Temp-voltage coefficient:		±15% ΔC Max. +15% -25% ΔC Max.
Dissipation factor	>25V rating: ≤25V rating:	2.5% max 3.5% max
Insulation resistance:	@25°C: @125°C:	>100GΩ or >1000ΩF whichever is less >10GΩ or >100ΩF whichever is less
Dielectric withstanding voltage	≤200V: 201-500V: >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:		<2.0% per decade
Test parameters:		1KHz, 1.0 ±0.2 VRMS, 25°C



X8R (S) Stable

Operating temperature range:		-55°C to 150°C
Temp. coefficient ≤150°C:		±15% ΔC Max.
Dissipation factor	>25V rating: ≤25V rating:	2.5% max 3.5% max
Insulation resistance	@25°C: @150°C:	>100GΩ or >1000ΩF whichever is less >10GΩ or >100ΩF whichever is less
Dielectric withstanding voltage	≤200V: 201-500V: >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:		<2.0% per decade
Test parameters:		1KHz, 1.0 ±0.2 VRMS, 25°C



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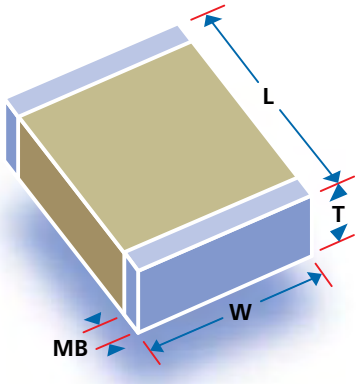
Chip Dimensions



Dimensions - inches (mm)

Size	Length (L)	Width (W)	Max. Thickness (T)*	Termination Band (MB)
0402	0.040 ± 0.004 (1.02 ± 0.102)	0.020 ± 0.004 (0.508 ± 0.102)	0.024 (0.610)	0.010 ± 0.006 (0.254 ± 0.152)
0504	0.050 ± 0.006 (1.27 ± 0.152)	0.040 ± 0.006 (1.02 ± 0.152)	0.044 (1.12)	0.014 ± 0.006 (0.356 ± 0.152)
RF0505	0.055 +0.015 -0.010 (1.4 +0.38 -0.25)	0.055 ± 0.015 (1.40 ± 0.381)	0.057 (1.45)	0.014 ± 0.006 (0.356 ± 0.152)
0603	0.060 ± 0.006 (1.52 ± 0.152)	0.030 ± 0.006 (0.762 ± 0.152)	0.035 (0.889)	0.014 ± 0.006 (0.356 ± 0.152)
0805	0.080 ± 0.008 (2.03 ± 0.203)	0.050 ± 0.008 (1.27 ± 0.203)	0.054 (1.37)	0.020 ± 0.010 (0.508 ± 0.254)
0907	0.090 ± 0.008 (2.29 ± 0.203)	0.070 ± 0.008 (1.78 ± 0.203)	0.060 (1.52)	0.020 ± 0.010 (0.508 ± 0.254)
1005	0.100 ± 0.008 (2.54 ± 0.203)	0.050 ± 0.008 (1.27 ± 0.203)	0.054 (1.37)	0.020 ± 0.010 (0.508 ± 0.254)
RF1111	0.110+0.025 -0.010 (2.79 +0.64 -0.25)	0.110 ± 0.015 (2.79 ± 0.381)	0.102 (2.59)	0.020 ± 0.010 (0.508 ± 0.254)
1206	0.125 ± 0.008 (3.18 ± 0.203)	0.060 ± 0.008 (1.52 ± 0.203)	0.064 (1.63)	0.020 ± 0.010 (0.508 ± 0.254)
1210	0.125 ± 0.008 (3.18 ± 0.203)	0.100 ± 0.008 (2.54 ± 0.203)	0.065 (1.65)	0.020 ± 0.010 (0.508 ± 0.254)
1515	0.150 ± 0.015 (3.81 ± 0.381)	0.150 ± 0.015 (3.81 ± 0.381)	0.130 (3.30)	0.030 ± 0.015 (0.762 ± 0.381)
1808	0.180 ± 0.012 (4.57 ± 0.305)	0.080 ± 0.008 (2.03 ± 0.203)	0.065 (1.65)	0.024 ± 0.014 (0.610 ± 0.356)
1812	0.180 ± 0.012 (4.57 ± 0.305)	0.125 ± 0.008 (3.18 ± 0.203)	0.065 (1.65)	0.024 ± 0.014 (0.610 ± 0.356)
1825	0.180 ± 0.012 (4.57 ± 0.305)	0.250 ± 0.015 (6.35 ± 0.381)	0.080 (2.03)	0.024 ± 0.014 (0.610 ± 0.356)
2020	0.200 ± 0.015 (5.08 ± 0.381)	0.200 ± 0.015 (5.08 ± 0.381)	0.180 (4.57)	0.024 ± 0.014 (0.610 ± 0.356)
2221	0.220 ± 0.015 (5.59 ± 0.381)	0.210 ± 0.015 (5.33 ± 0.381)	0.080 (2.03)	0.030 ± 0.015 (0.762 ± 0.381)
2225	0.220 ± 0.015 (5.59 ± 0.381)	0.250 ± 0.015 (6.35 ± 0.381)	0.080 (2.03)	0.030 ± 0.015 (0.762 ± 0.381)
2520	0.250 ± 0.015 (6.35 ± 0.381)	0.200 ± 0.015 (5.08 ± 0.381)	0.180 (4.57)	0.030 ± 0.015 (0.762 ± 0.381)
RF2525	0.230 +0.020 -0.012 (5.84 +0.51 -0.30)	0.250 ± 0.015 (6.35 ± 0.381)	0.165 (4.19)	0.030 ± 0.015 (0.762 ± 0.381)
3333	0.330 ± 0.017 (8.38 ± 0.432)	0.330 ± 0.017 (8.38 ± 0.432)	0.250 (6.35)	0.030 ± 0.015 (0.762 ± 0.381)
3530	0.350 ± 0.018 (8.89 ± 0.457)	0.300 ± 0.015 (7.62 ± 0.381)	0.250 (6.35)	0.030 ± 0.015 (0.762 ± 0.381)
4040	0.400 ± 0.020 (10.2 ± 0.508)	0.400 ± 0.020 (10.2 ± 0.508)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
4540	0.450 ± 0.023 (11.4 ± 0.584)	0.400 ± 0.020 (10.2 ± 0.508)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
5440	0.540 ± 0.027 (13.7 ± 0.686)	0.400 ± 0.020 (10.2 ± 0.508)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
5550	0.550 ± 0.028 (14.0 ± 0.711)	0.500 ± 0.025 (12.7 ± 0.635)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
6560	0.650 ± 0.033 (16.5 ± 0.838)	0.600 ± 0.030 (15.2 ± 0.762)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
7565	0.750 ± 0.038 (19.1 ± 0.965)	0.650 ± 0.033 (16.5 ± 0.838)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)

* Non standard thicknesses are available - consult the sales office for details.

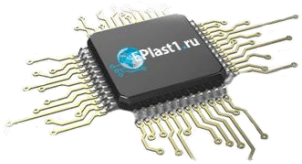
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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